



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 10/600,232

Filed: June 19, 2003

For: SEMICONDUCTOR PACKAGE
WITH STACKED SUBSTRATES AND
MULTIPLE SEMICONDUCTOR DICE

Confirmation No.: 9505

Examiner: A. Williams

Group Art Unit: 2826

Attorney Docket No.: 2269-2809.6US
(96-0031.05/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

September 30, 2004
Date

Deborah L. Hendricks
Signature

Deborah L. Hendricks
Name (Type/Print)

AMENDMENT

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of June 30, 2004, whose initial period of response is set to expire on September 30, 2004.

Amendments to the Title appear on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 15 of this paper.

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01 FC:1202
02 FC:1201

162.00 OP
86.00 OP

Serial No. 10/600,232

IN THE TITLE:

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

SEMICONDUCTOR ASSEMBLY OF ~~PACKAGE WITH~~ STACKED SUBSTRATES AND
MULTIPLE SEMICONDUCTOR DICE